(New Nonprovisional Applications Under 37 CFR § 1.53(b))

TO THE COMMISSIONER FOR PATENTS:

Transmitted herewith is the patent application of ☐ first named inventor, <u>Steven C. Avanzino</u>, entitled AN INTEGRATED CIRCUIT WITH DIELECTRIC DIFFUSION BARRIER LAYER FORMED TO SETWEEN INTERCONNECTS AND INTERLAYER DIELECTRIC LAYERS, for a(n).

Original Patent A						
	cation (prior application					
☐ Continuation ☐ Divisional ☐ Continuation-in-part (CIP) of prior application No: 10/226,520 Filed on: 8/22/02.						
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☐ Signe	d Statement Deleting	Inventor(s) Named in the	Prior Applic	ation. (37 C	CFR § 163(d)(2)).
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service under 37 CFR § 1.10 on the date indicated			By:	Wiki	John	iam
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Mail Stan Botant Amplication			Mikio Ishimaru,			
Mail Stop Patent Application Commissioner for Patents			Attorney of Record			
P.O. Box 14:	50		Reg. No. 27449			
Alexandria, VA 22313-1450						
			Date:		6, 2003	
By: Vickie.	^ .		Date	June 2	.,	
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NONPUBLICATION REQUEST UNDER 35 U.S.C. 122(b)(2)(B)(i)	First Name	ad Inventor Steven C. Avanzino et al. AN INTEGRATED CIRCUIT WITH DIELECTRIC DIFFUSION BARRIER LAYER FORMED BETWEEN INTERCONNECTS AND INTERLAYER DIELECTRIC LAYERS	
	Atty Docke	t Number	F0361.C1.D1

I hereby certify that the invention disclosed in the attached application has not and will not be the subject of an application filed in another country, or under a multilateral agreement, that requires publication at eighteen months after filing.

I hereby request that the attached application not be published under 35 U.S.C. 122(b).

June 26, 2003	Mikio Sohiman			
Date	Signature			
(408) 738-0592	Mikio Ishimaru			
Telephone number	Typed or printed name			

This request must be signed in compliance with 37 CFR 1.33(b) and submitted with the application upon filing.

Applicant may rescind this nonpublication request at any time. If applicant rescinds a request that an application not be published under 35 U.S.C. 122(b), the application will be scheduled for publication at eighteen months from the earliest claimed filing date for which a benefit is claimed.

If applicant subsequently files an application directed to the invention disclosed in the attached application in another country, or under a multilateral international agreement, that requires publication of applications eighteen months after filing, the applicant must notify the United States Patent and Trademark Office of such filing within forty-five (45) days after the date of the filing of such foreign or international application. Failure to do so will result in abandonment of this application (35 U.S.C. 122(b)(2)(B)(iii)).

This collection of Information is required by 37 CFR 1.21(3), The Information is required to obtain or retain a benefit by the public which is to file (and by the USPTO by process) an application. Confidentiality is governed by 38 US, C. 122 and 37 CFR 1.1.4. This collection is estimated she finitudes to complete including gathering, preparing, and submitting the completed application form to the USPTO. Time will vary depending upon the individual case. Any comments on the amount of time you are required to complete this form and/or suppessions for reducing this budden, should be sent to the Chief Information (Officer, U.S. Patent Trademark Office, U.S. Department of Commerce, P.O. Box 1450, Alexandria, VA 22313-1450, DO NOT SEND FEES OR COMPLETED FORMS TO THIS ADDRESS. SEND TO: Commissioner for Patents P.O., Box 1450, Alexandria, VA 22313-1450.